Application No.: Not Yet Assigned Docket No.: 0033-1001PUS1

IN THE ABSTRACT OF THE DISCLOSURE

Please amend the Abstract of Disclosure as follows:

An aluminum stabilization stacked body (101) formed by stacking a stabilization layer (103) formed with a metal and having a thickness of 0.001-1 μ m with any of a sputtering method, a deposition method and an ion plating method on a whole surface of a thin film (102) having a surface formed with aluminum.

3 CG/smt